

Input Select Decoding for PI6C2408 (-1, -1H,-4)

SEL2	SEL1	OUTA [1-4]	OUTB [1-4]	Output Source	PLL
0	0	3-State	3-State	PLL	OFF
0	1	PLL	3-State	PLL	ON
1	0	CLKIN	CLKIN	CLKIN	OFF
1	1	PLL	PLL	PLL	ON

Input Select Decoding for PI6C2408 (-2,-3)

SEL2	SEL1	OUTA [1-4]	OUTB [1-4]	Output Source	PLL
0	0	3-State	3-State	PLL	OFF
0	1	PLL	3-State	PLL	ON
1	0	CLKIN	CLKIN/2	CLKIN	OFF
1	1	PLL	PLL	PLL	ON

Input Select Decoding for PI6C2408-6

SEL2	SEL1	OUTA [1-4]	OUTB [1-4]	Output Source	PLL
0	0	3-State	3-State	PLL	OFF
0	1	CLKIN	CLKIN/2	CLKIN	OFF
1	0	PLL	PLL	PLL	ON
1	1	PLL	PLL/2	PLL	ON

PI6C2408 Configurations

Device	Feedback From	OUTA [1-4] Frequency	OUTB [1-4] Frequency
PI6C2408-1	OUTA or OUTB	CLKIN	CLKIN
PI6C2408-1H	OUTA or OUTB	CLKIN	CLKIN
PI6C2408-2	OUTA	CLKIN	CLKIN/2
PI6C2408-2	OUTB	2X CLKIN	CLKIN
PI6C2408-3	OUTA	2X CLKIN	CLKIN or CLKIN ⁽¹⁾
PI6C2408-3	OUTB	4X CLKIN	2X CLKIN
PI6C2408-4	OUTA or OUTB	2X CLKIN	2XCLKIN
PI6C2408-6	OUTA	CLKIN	CLKIN or CLKIN/2
PI6C2408-6	OUTB	CLKIN or 2X CLKIN	CLKIN

Note:

1. Output phase is indeterminant (0° or 180° from CLKIN)

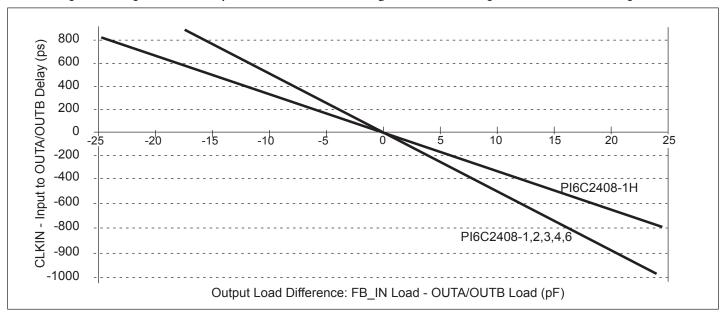


Pin Description

Pin	Signal	Description
1	CLKIN	Input clock reference frequency (weak pull-down)
2, 3, 14, 15	OUTA[1-4]	Clock output, Bank A (weak pull-down)
4, 13	V _{DD}	3.3V supply
5, 12	GND	Ground
6, 7, 10 ,11	OUTB[1-4]	Clock output, Bank B (weak pull-down)
8	SEL2	Select input, bit 2 (weak pull-up)
9	SEL1	Select input, bit 1 (weak pull-up)
16	FB_IN	PLL feedback input

Zero Delay and Skew Control

CLKIN Input to Output Bank Delay vs. Difference in Loading between FB_IN pin and OUTA/OUTB pins



The relationship between loading of the FB_IN signal and other outputs determines the input-output delay. Zero delay is achieved when all outputs, including feedback, are loaded equally.



Maximum Ratings (Above which the useful life may be impaired. For user guidelines, not tested)

Supply Voltage to Ground Potential0.5V to +7.0V
DC Input Voltage (Except CLKIN)0.5V to V _{DD} +0.5V
DC Input Voltage CLKIN0.5 to 7V
Storage Temperature65°C to +150°C
Maximum Soldering Temperature (10 seconds)260°C
Junction Temperature
Static Discharge Voltage*>2000V

^{*}per MIL-STD-883, Method 3015

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Operating Conditions

Parameter	Description	Min.	Max.	Units		
17	C1 V-14	Commercial	3.0	3.6	3.7	
V _{DD}	Supply Voltage Industrial		3.135	3.465	V	
т.	Commerical Operating Temperature		0	70	0.0	
TA	Industrial Operating Temperature		-40	85	°C	
C-	Load Capacitance, below 100 MHz		3/4	30		
C _L Load Capacitance, from 100 MHz to		00 MHz to 140MHz	3/4	15	pF	
C _{IN}	Input Capacitance	3/4	7			

DC Electrical Characteristics for Industrial Temperature Devices

Parameter	Description	Test Conditions	Min.	Max.	Units	
VIL	Input LOW Voltage			0.8	V	
V _{IH}	Input HIGH Voltage		2.0		V	
I _{IL}	Input LOW Current	$V_{IN} = 0V$		50.0		
I _{IH}	Input HIGH Current	$V_{\rm IN} = V_{\rm DD}$		100.0	μΑ	
V _{OL}	Output LOW Voltage	I _{OL} = 8mA (-1, -2, -3, -4, -6); I _{OL} = 12mA (-1H)		0.4	V	
Vон	Output HIGH Voltage	$I_{OH} = -8mA (-1, -2, -3, -4, -6); I_{OH} = -12mA (-1H)$	2.4		V	
I _{DD} (PD mode)	Pwr Dwn Supply Current	SEL1 = 0 (-1, -2, -3, -4, -1H); SEL2 = 0 (-6)		25.0	μΑ	
		Unloaded outputs 100 MHz, Select inputs at V _{DD} or		54.0		
I_{DD}	GND Supply Current		70.0 (-1H)	mA		
-55	***	Unloaded outputs 66 MHz, CLKIN, except (-1H)		39.0		
		Unloaded outputs 33MHz, CLKIN, except (-1H)		20.0		



AC Electrical Characteristics for Industrial Temperature Devices

Parameters	Name	Test Conditions	Min.	Тур.	Max.	Units
Г.	0.4.45	30pF load	10		100	MIL
Fo	Output Frequency	15pF load	10		140	MHz
		Measured at $V_{DD}/2$, F_{OUT} <66.67MHz 30pF load	10			
	Duty Cycle ⁽¹⁾ (-1, -2, -3, -4, -6)	Measured at $V_{DD}/2$, F_{OUT} <140 MHz 15pF load	40		60	
	(-1, -2, -3, -4, -0)	Measured at $V_{DD}/2$, F_{OUT} <45 MHz 30pF load	45]
t_{DC}		Measured at $V_{DD}/2$, F_{OUT} <66.67MHz 30pF load	45	50	55	%
	Duty Cycle ⁽¹⁾ (-1H)	Measured at $V_{DD}/2$, F_{OUT} <140 MHz 15pF load	40		60	
		Measured at $V_{DD}/2$, F_{OUT} <45MHz 30pF load	45		55	
	Rise Time ⁽¹⁾	Measured between 0.8V and 2.0V, 30pF load			2.5	
t_R	(-1, -2, -4, -6)	Measured between 0.8V and 2.0V, 15pF load			1.8	ns
	Rise Time ⁽¹⁾ (-1H)	Measured between 0.8V and 2.0V, 30pF load			1.6	
	Fall Time ⁽¹⁾ (-1, -2, -4, -6)	Measured between 0.8V and 2.0V, 30pF load			2.2	
t_{F}		Measured between 0.8V and 2.0V, 15pF loa			1.5	
	Fall Time ⁽¹⁾ (-1H)	Measured between 0.8V and 2.0V, 30pF load			1.25	
t _{SK(O)}	Output to Output Skew(1) within same Bank	All outputs caually loaded			250	
	Output Bank A to Output Bank B Skew(1)	- All outputs equally loaded			400	
t _o	Delay, CLKIN Rising Edge to FB_IN Rising Edge ⁽¹⁾	Measured at $V_{\rm DD}/2$			900	ps
t _{SK(D)}	Device-to-Device Skew ⁽¹⁾	Measured at $V_{DD}/2$ on FB_IN pins of devices		0	500	
t _{SLEW}	Output Slew Rate ⁽¹⁾	Measured between 0.8V & 2.0V on –1H device using Test Crt #2	1			V/ns
	Cycle-to-Cycle Jitter(1)	Measured at 66.67 MHz, loaded 30pF load			250	
t	(-1, -1H, -4)	Measured at 140 MHz, loaded 15pF load			150	ne
t_{jit}	Cycle-to-Cycle Jitter ⁽¹⁾ (-2, -6)	Measured at 66.67 MHz, loaded 30pF load			400	ps
t _{LOCK}	PLL Lock Time ⁽¹⁾	Stable power supply, valid clocks presented on CLKIN and FB_IN pins			1.0	ms

Notes

1. See Switching Waveforms on page 7.



DC Electrical Characteristics for Commercial Temperature Devices

Parameter	Description	Test Conditions	Min.	Max.	Units
V_{IL}	Input LOW Voltage	3/4	3/4	0.8	V
V_{IH}	Input HIGH Voltage	3/4	2.0	3/4	V
I _{IL}	Input LOW Current	$V_{IN} = 0V$	3/4	50	
I_{IH}	Input HIGH Current	$V_{\rm IN} = V_{\rm DD}$	3/4	100	μΑ
V _{OL}	Output LOW Voltage	I _{OL} = 8mA (-1, -2, -3, -4, -6); I _{OL} = 12mA (-1H)	3/4	0.4	V
VoH	Output HIGH Voltage	$I_{OH} = -8mA (-1, -2, -3, -4, -6); I_{OH} = -12mA (-1H)$	2.4	3/4	V
I _{DD} (PD mode)	Power Down Supply Current	SEL1 = 0 (-1,-2,-3,-4,-1H); SEL2 = 0 (-6)	3/4	12	μΑ
I _{DD}	Supply Current	Unloaded outputs, 66.67 MHz, Select inputs at V_{DD} or GND	3/4	39	A
I_{DD}	Supply Current	Unloaded outputs 100 MHz Select Inputs @ V _{DD} or GND	3/4	54	mA

AC Electrial Characteristics for Commercial Temperature Device

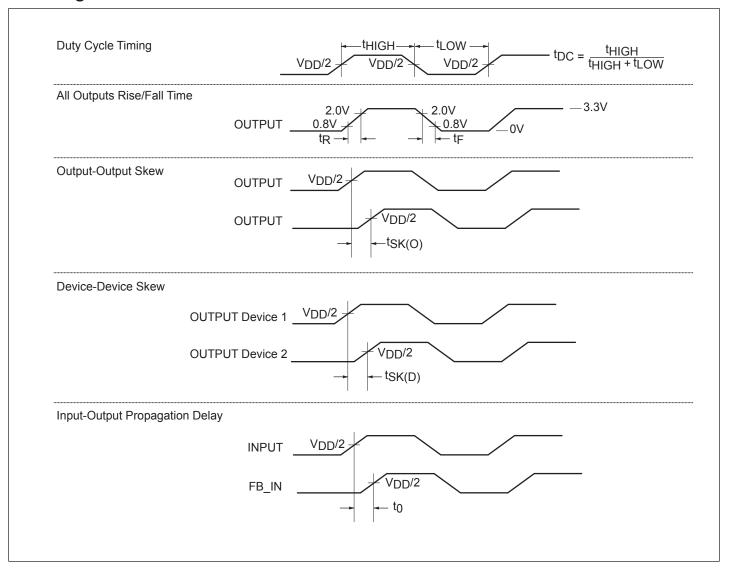
Param- eter	Name	Test Conditions	Min.	Typ.	Max.	Units	
T.	Output Frequency	30pF load	10		100	MHz	
Fo		15pF load			140		
	Duty Cycle ⁽¹⁾ (-1H)	Measured at V _{DD} /2, for high drive output	igh drive output 45 50 55		55		
t_{DC}	Duty Cycle (-1, -2, -3, -4, -6)	Measured at $V_{\mathrm{DD}}/2$, for normal drive output	40	50	60	- %	
	Rise Time ⁽¹⁾ @30pF	Measured between 0.8V and 2.0V			2.5	ns	
t_R	Rise Time ⁽¹⁾ @15pF	Measured between 0.8V and 2.0V			1.8		
	Rise Time ⁽¹⁾ @30pF (-1H)	Measured between 0.8V and 2.0V			1.5		
	Fall Time ⁽¹⁾ @30pF	Measured between 0.8V and 2.0V			2.2		
t_{F}	Fall Time ⁽¹⁾ @15pF	Measured between 0.8V and 2.0V			1.5		
	Fall Time ⁽¹⁾ @30pF (-1H)	Measured between 0.8V and 2.0V			1.25		
	Output-to-Output Skew ⁽¹⁾ within same bank	All outputs equally loaded, V _{DD} /2			250		
t _{SK(O)}	Output Bank A to Output Bank B Skew	All outputs equally loaded, V _{DD} /2			400		
t _o	Input-to-Output Delay, CLKIN Rising Edge to FB_IN Rising Edge ⁽¹⁾	Measured at V _{DD} /2			900	ps	
t _{SK(D)}	Device to Device Skew ⁽¹⁾	Measured at V _{DD} /2 on FB_IN pins of devices		0	500		
t _{SLEW}	Output Slew Rate ⁽¹⁾	Measured between 0.8V and 2.0V on -1H device using Test Circuit #2	1			V/ns	
		Measured at 66.67 MHz, loaded 30pF output			250		
t _{JIT}	Cycle-to-Cycle Jitter (1) (-1,-1H,-4)	Measured at 140 MHz, loaded 15pF output			150	ps	
	Cycle-to-Cycle Jitter ⁽¹⁾ (-2,-3,-6)	Measured at 66.7 MHz, loaded 30pF output			400		
t_{LOCK}	PLL Lock Time ⁽¹⁾	Stable power supply, valid clocks presented on CLKIN and FB_IN pins			1.0	ms	

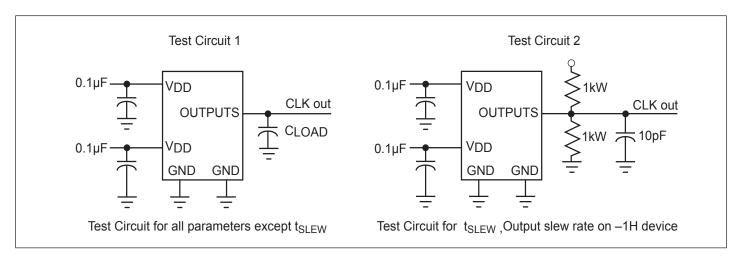
Notes:

1. See Switching Waveforms on page 7.



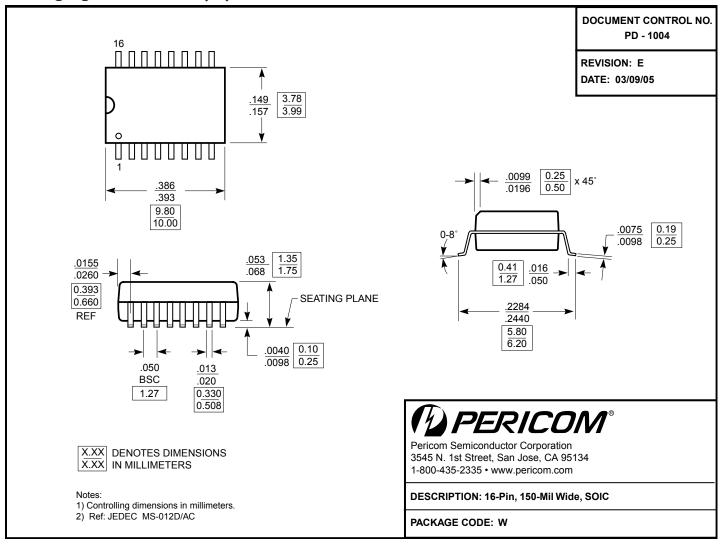
Switching Waveforms







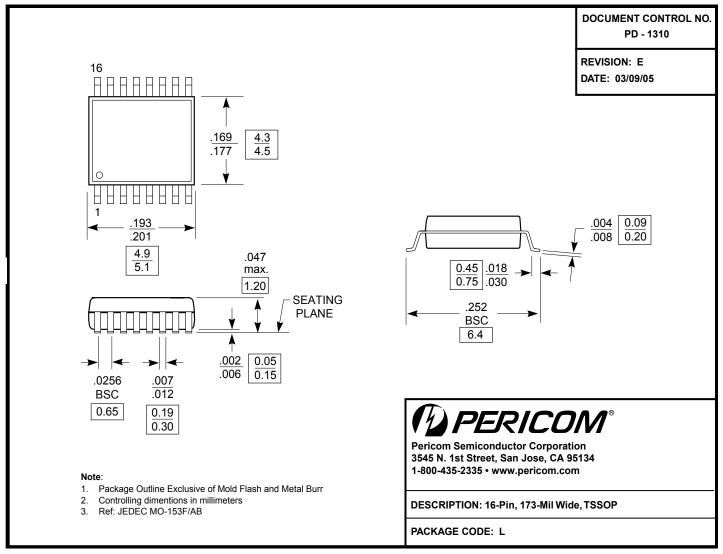
Packaging: 16-Pin SOIC (W)



 $Note: For \ latest\ package\ info,\ please\ check:\ http://www.pericom.com/products/packaging/mechanicals.php$



Packaging: 16-Pin TSSOP (L)



Note: For latest package info, please check: http://www.pericom.com/products/packaging/mechanicals.php



Ordering Information

Commercial Temperature Device

Ordering Code	Package Code	Description	Operating Range
PI6C2408-3WE	W	Pb-free & Green, 16-pin 150-mil SOIC	Commercial
PI6C2408-1LE	L	Pb-free & Green, 16-pin 173-mil TSSOP	Commercial
PI6C2408-1HLE	L	Pb-free & Green, 16-pin 173-mil TSSOP	Commercial
PI6C2408-4LE	L	Pb-free & Green, 16-pin 173-mil TSSOP	Commercial
PI6C2408-1LE	L	Pb-free & Green 16-pin 173-mil TSSOP	Commercial
PI6C2408-1HLE	L	Pb-free & Green 16-pin 173-mil TSSOP	Commercial
PI6C2408-1HLEX	L	Pb-free & Green, 16-pin 173-mil TSSOP	Commercial

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free and Green
- Adding an X suffix = Tape/Reel

Industrial Temperature Device

Ordering Code	Package	Description	Operating Range
PI6C2408-3WIE	W	Pb-free & Green, 16-pin 150-mil SOIC	Industrial
PI6C2408-1LIE	L	Pb-free & Green, 16-pin 173-mil TSSOP	Industrial

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free and Green
- Adding an X suffix = Tape/Reel